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FCI7N60 N-Channel SuperFET[®] MOSFET $600 V, 7 A, 600 m\Omega$

Features

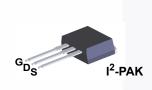
- 650V @ T_J = 150°C
- Typ. R_{DS(on)} = 530 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 23 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 60 pF)
- 100% Avalanche Tested
- RoHS compliant

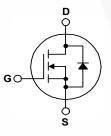
Application

- Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





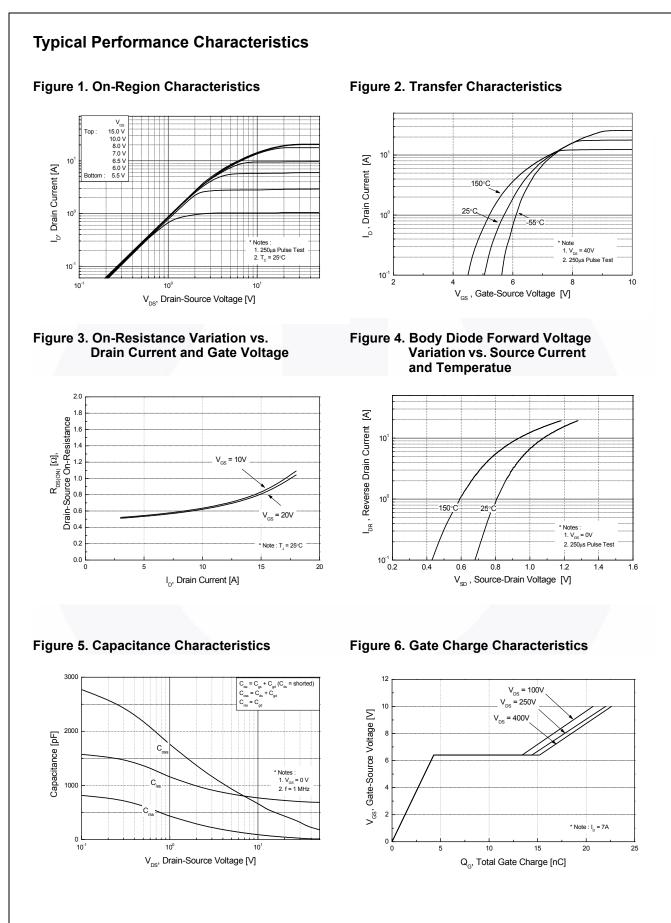
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCI7N60	Unit V		
V _{DSS}	Drain to Source Voltage	600			
I _D	Drain Current	- Continuous (T _C = 25°C)	7	Α	
	Drain Current	- Continuous (T _C = 100 ^o C)	4.4		
I _{DM}	Drain Current	- Pulsed (Note 1)	21	A	
V _{GSS}	Gate to Source Voltage	±30	V		
E _{AS}	Single Pulsed Avalanche	Energy (Note 2)	230	mJ	
I _{AR}	Avalanche Current	(Note 1)	7	Α	
E _{AR}	Repetitive Avalanche Ene	rgy (Note 1)	8.3	mJ	
dv/dt	Peak Diode Recovery dv/	dt (Note 3)	4.5	V/ns	
P _D	Dower Dissinction	(T _C = 25°C)	83	W	
	Power Dissipation	- Derate Above 25°C	0.67	W/ºC	
T _J , T _{STG}	Operating and Storage Te	-55 to +150	°C		
TL	Maximum Lead Temperat	300	°C		
	1				

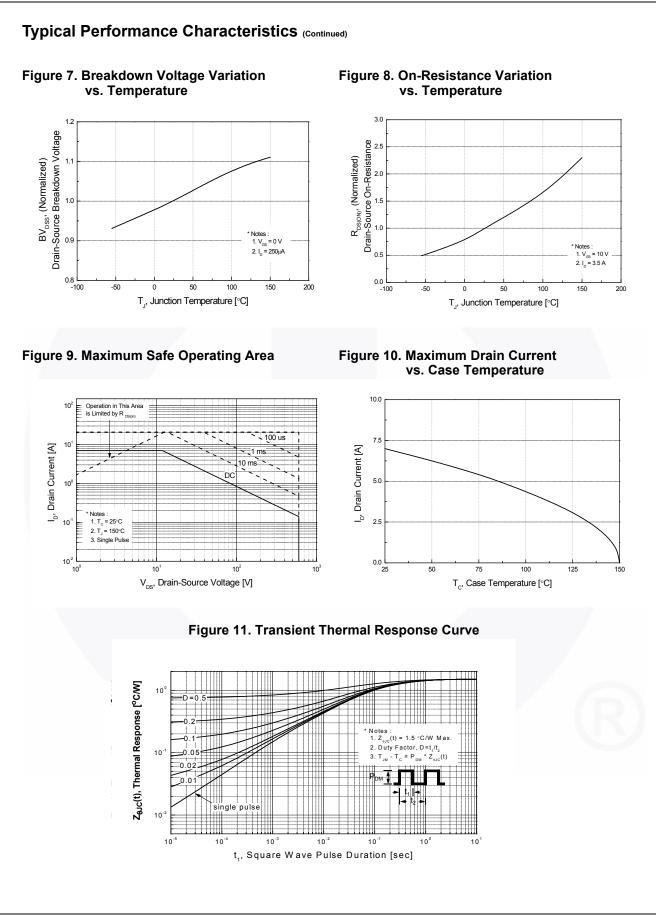
Thermal Characteristics

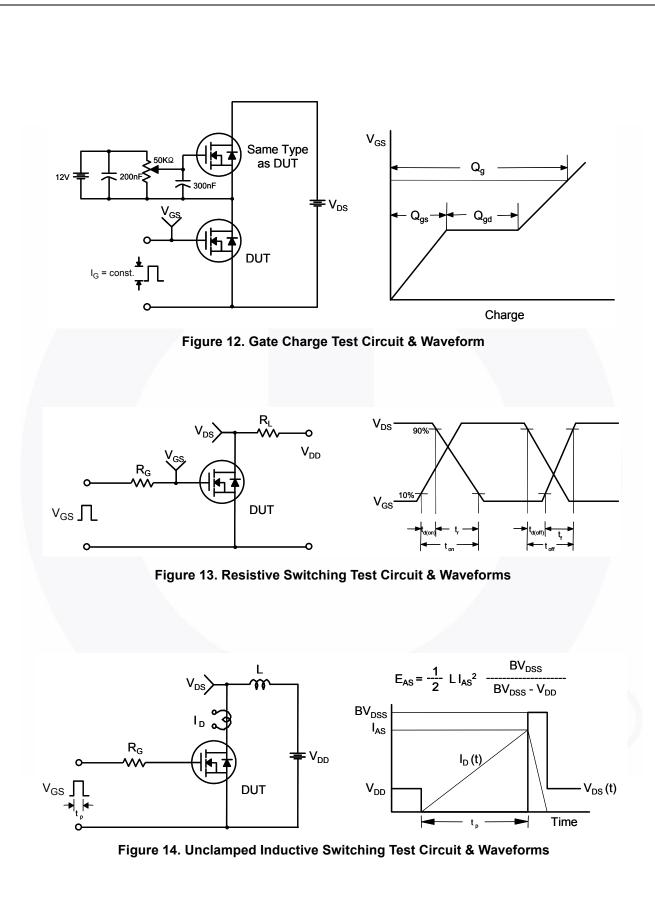
Symbol	Parameter	FCI7N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

Part Nu	mber	er Top Mark Pac		age Packing Method Reel Size			Tape Width		Qua	ntity
FCI7N60		FCI7N60	I ² -PAK	<	Tube	N/A		N/A	50 units	
Electrica	al Chara	cteristics T _c =	25ºC unless	otherwise	noted.					
Symbol	cal Characteristics T _C = 25°C unl			Test Conditions			Min.	Тур.	Max.	Unit
Off Chara	cteristics					<u> </u>				
				$V_{a} = 0$	V L = 250 uA	$T_{-} = 25^{\circ}C$	600	-	-	V
BV _{DSS}	Drain to	Drain to Source Breakdown Voltage		$V_{GS} = 0 V, I_D = 250 \mu A, T_C = 25^{\circ}C$ $V_{GS} = 0 V, I_D = 250 \mu A, T_C = 150^{\circ}C$			-	- 650	-	V
∆BV _{DSS}	Breakdov	Breakdown Voltage Temperature					-	050	-	-
$/\Delta T_J$		Coefficient			I_D = 250 µA, Referenced to 25 ^o C				-	V/°C
BV _{DS}	Drain-So	urce Avalanche Breal	kdown	V -0	$\lambda = 7$		_	700	-	V
-	Voltage	Voltage			$V_{GS} = 0 V, I_D = 7 A$			700	-	V
I _{DSS}	Zero Gat	Zero Gate Voltage Drain Current		$V_{DS} = 600 V, V_{GS} = 0 V$ $V_{DS} = 480 V, T_C = 125^{\circ}C$			-	-	1	μA
·D88	2010 000						-	-	10	μη
I _{GSS}	Gate to Body Leakage Current			V_{GS} = ±30 V, V_{DS} = 0 V			-	-	±100	nA
On Chara	cteristics									
V _{GS(th)}	Gate Thr	Gate Threshold Voltage			_{DS} , I _D = 250 μ/	A	3.0	-	5.0	V
R _{DS(on)}		ain to Source On Res	istance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}$			-	0.53	0.6	Ω
9 _{FS}	Forward	Forward Transconductance		$V_{DS} = 40 \text{ V}, I_D = 3.5 \text{ A}$			-	6	-	S
	Choractor	riotion								
Dynamic (- 10		
C _{iss}		Input Capacitance		V _{DS} = 25 V, V _{GS} = 0 V,			-	710	920	pF
C _{oss}	Output Capacitance Reverse Transfer Capacitance Output Capacitance 5% ctime Output Capacitance			f = 1.0 MHz		-	380	500	pF	
C _{rss}			_	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz V _{DS} = 0 V to 400 V, V _{GS} = 0 V			-	34	-	pF
C _{oss}			_				-	22	29	pF
C _{oss(eff.)}	Effective	Output Capacitance	_	$V_{\rm DS} = 0$	v to 400 v, v _C	_{SS} = 0 V	-	60	-	pF
Switching	Charact	eristics								
t _{d(on)}	Turn-On Delay Time						-	35	80	ns
t _r	Turn-On	Turn-On Rise Time		$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 7 \text{ A}, V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$			-	55	120	ns
t _{d(off)}	Turn-Off Delay Time						- /	75	160	ns
t _f	Turn-Off	Fall Time				(Note 4)	-	32	75	ns
Q _{g(tot)}	Total Gat	e Charge at 10V		$V_{De} = 48$	_{os} = 480 V, I _D = 7 A,		7-	23	30	nC
Q _{gs}	Gate to S	ource Gate Charge		$V_{GS} = 10 V$			-	4.2	5.5	nC
Q _{gd}	Gate to D	rain "Miller" Charge		(Note 4)			-	11.5	-	nC
	rce Diod	e Characteristic	5							
I _S	Maximum Continuous Drain to Source Diode Forward Current					-	-	7	А	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward				vard Current		-	-	21	Α
V _{SD}	Drain to Source Diode Forward Voltage			V _{GS} = 0 V, I _{SD} = 7 A			-	-	1.4	V
t _{rr}	Reverse	Recovery Time	<u> </u>	$V_{GS} = 0 V, I_{SD} = 7 A,$		-	360		ns	
 Q _{rr}	Reverse Recovery Charge			$dI_{\rm F}/dt = 100 {\rm A}/{\mu {\rm s}}$		-	4.5		μC	
Notes:	I			1						<u> </u>
	g: pulse-width li	mited by maximum junction t	emperature.							
		25Ω , starting T _J = 25°C.								



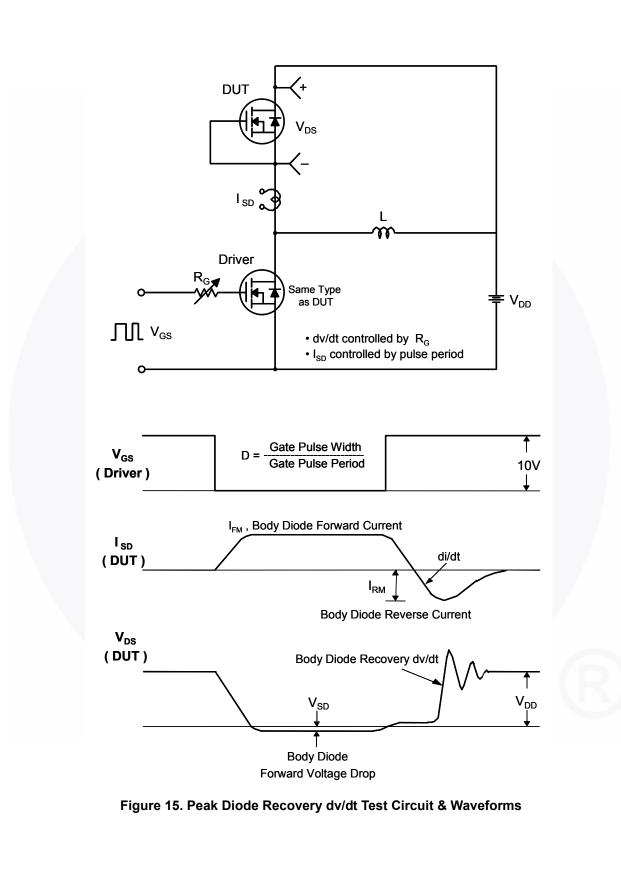
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FCI7N60 — N-Channel SuperFET[®] MOSFET

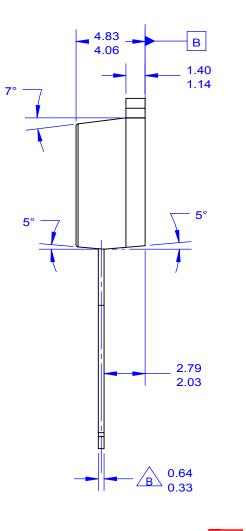
FCI7N60 — N-Channel SuperFET[®] MOSFET



10.29 Α 9.65 8.33 6.22 1.40 1.00 7.88 6.86 9.65 8.64 (+)2 3 1 3.96 B 2.80 (2.13)-14.73 12,70 1.78 <u>____</u> 1.14 SEE NOTE "G' 2.54 0.90 ∕B∖ 0.64 5.08 ⊕ 0.254 A B

NOTES:

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